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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231, on May 28, 2002.

Joseph A. Herndon, Registration No. 50,469

Name of applicant, assignee or Registered Representative

Joseph A. Herndon
Signature

May 28, 2002
Date of Signature

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TC 1700

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
Honeywell Docket No. H0002988
(MBHB 01-1612)

In re Application of:	William P. Platt)	Examiner: Not Assigned
)	
Serial No.	10/083,978)	Art Unit: Not Assigned
)	
Filed:	February 27, 2002)	
)	
For:	BONDING FOR A MICRO-ELECTRO-MECHANICAL (MEMS) AND MEMS-BASED DEVICES)	
)	

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INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
Washington, D.C. 20231

Sir:

Pursuant to the requirements of 37 CFR §§ 1.56, 1.97 and 1.98, Applicants hereby disclose the references listed on the attached PTO Form 1449. A copy of each of the references listed on the attached PTO Form 1449 is enclosed herewith, or has already been submitted or cited in a prior application in accordance with 37 CFR § 1.98(d). Applicants request that these documents be considered and made of record in this application.

BEST AVAILABLE COPY

I. REFERENCES DISCLOSED

A. U.S. Patents

<u>PATENT NO.</u>	<u>ISSUED</u>	<u>INVENTOR(S)</u>
6,234,378 B1	May 22, 2001	Ford et al.
6,114,188	September 5, 2000	Oliver et al.
5,106,009	April 21, 1992	Humpston et al.
3,599,123	August 10, 1971	Krause

II. CONCLUSION

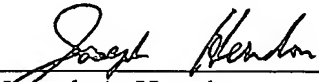
This Information Disclosure Statement is being filed within three months after the filing date of the application, or before the mailing of the first office action on the merits, and no certification under 37 CFR §1.97(e) or fee under 37 CFR §1.17(p) is required. Alternatively, each reference contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a foreign counterpart application not more than three months prior to the filing of this Information Disclosure Statement.

Applicants believe that none of these references, alone or in combination, disclose, teach, or suggest Applicants' claimed invention. Applicants, however, wish to bring these documents to the attention of the Examiner for both the Examiner and the public to see. Applicants respectfully request that the Examiner review the entire disclosure of these documents and make these documents of record.

Early and favorable consideration is earnestly solicited.

Respectfully submitted,

Dated: May 28, 2002



Joseph A. Herndon
Reg. No. 50,469

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Commissioner for Patents
Washington, D.C. 20231

Sir:

TRANSMITTAL LETTER

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1. We are transmitting herewith the attached:

- a) Information Disclosure Statement (w/4 references and patents);
- b) PTO Form 1449; and
- c) Post Card

2. With respect to additional fees:

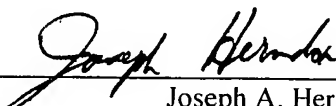
- ☒ A. No additional fee is required.
- ☐ B. Attached is a check in the amount of \$0.00.

3. **General Authorization:** Please charge any additional fees or credit overpayment to Deposit Account No. 13-2490. A duplicate copy of this sheet is enclosed.

4. **CERTIFICATE OF MAILING UNDER 37 CFR § 1.8:** The undersigned hereby certifies that this Transmittal Letter and the paper, as described in paragraph 1 hereinabove, are being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231 on this 28th day of May, 2002.

Dated: May 28, 2002

By :



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